TOSHIBA Photointerrupter Infrared LED + Phototransistor

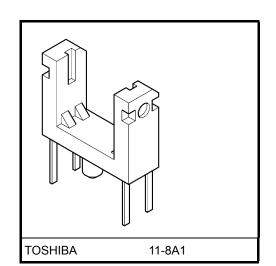
## **TLP841**

Copiers, Printers and Fax Machines VCRs and CD Players Various Position Detection Sensor

The TLP841 is photointerrupter which consists of a GaAs infrared LED and an Si phototransistor. With gap width as wide as 5mm, it is a compact package.

- Compact package:  $7.5(w) \times 6.3(h) \times 2.6(d)mm$
- Printed wiring board direct mounting type (with a locating pin)
- Board thickness: 1.6mm or less
- Gap width: 5 mm
- Resolution: Slit width = 0.5 mm
- Current transfer ratio: IC/IF = 2.5% (min)
- High response speed:  $t_r$ ,  $t_f = 15 \mu s$  (typ.)
- Material of the package: Polybutylene terephthalate (UL94V-0)

#### Absolute Maximum Ratings (Ta = 25°C)



Weight: 0.1 g (typ.)

Unit

# Product No. Weekly code

Marking (Note 2)

## Symbol Characteristics Rating

		-	-	
LED	Forward current	١ <sub>F</sub>	30	mA
	Forward current derating (Ta>25°C)	ΔI <sub>F</sub> /°C	-0.33	mA/°C
	Reverse voltage	V <sub>R</sub>	5	V
	Collector-emitter voltage	V <sub>CEO</sub>	35	V
5	Emitter-collector voltage	V <sub>ECO</sub>	5	V
Detector	Collector power dissipation	PC	75	mW
Det	Collector power dissipation derating (Ta>25°C)	ΔP <sub>C</sub> /°C	-1	mW/°C
	Collector current	ΙC	50	mA
Ope	erating temperature range	T <sub>opr</sub>	-30 to 85	°C
Stor	rage temperature range	T <sub>stg</sub>	-40 to 100	°C
Solo	dering temperature (5s) (Note 1)	T <sub>sol</sub>	260	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: At least 1.5mm from body

Note 2: Weekly code: (Three digits)



Week of manufacture (01 for first week of year, continues up to 52 or 53) Year of manufacture

(One low-order digits of calendar year)

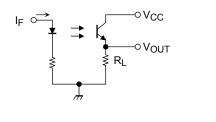
#### **Operating Ranges**

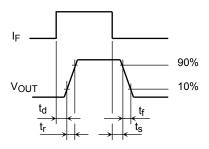
Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	V <sub>CC</sub>	_	5	24	V
Forward current	١ <sub>F</sub>	_	_	20	mA
Operating temperature range	T <sub>opr</sub>	-10	_	75	°C

### **Optical and Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test conditions	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.00	1.23	1.40	V
LED	Reverse current	I <sub>R</sub>	$V_R = 5 V$	_	—	10	μA
	Peak emission wavelength	λP	I <sub>F</sub> = 10 mA		940		nm
Detector	Dark current	I <sub>D</sub> (I <sub>CEO</sub> )	$V_{CE} = 24 V, I_F = 0$	_	_	0.05	μA
Dete	Peak sensitivity wavelength	λP	—		820	_	nm
	Current transfer ratio	I <sub>C</sub> /I <sub>F</sub>	$V_{CE} = 2 \text{ V}, \text{ I}_{F} = 10 \text{ mA}$	2.5	—	50	%
Coupled	Collector-emitter saturation voltage	V <sub>CE (sat)</sub>	I <sub>F</sub> = 20 mA, I <sub>C</sub> = 0.25 mA		0.1	0.4	V
Ō	Rise time	tr	$V_{CE}$ = 5 V, I <sub>C</sub> = 1 mA, R <sub>L</sub> = 1 k $\Omega$	_	15	50	
	Fall time	t <sub>f</sub>	(Note 3)	_	15	50	μS

Note 3 : Switching time measurement circuit and waveform





## Precautions

• When removing flux with chemicals after soldering, clean only the leads on the soldering side; do not dip the whole package for cleaning.

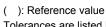
Chemicals remaining on an LED or photo transistor light emitter or receiver, if any, would have a bad influence to the optical characteristics and it may severely lower the conversion efficiency.

- Care must be taken in relation to the environment in which the device is to be installed. Oil or chemicals may cause the package to melt or crack.
- The device should be mounted on an unwarped surface.
- Conversion efficiency falls over time due to the current which flows in the infrared LED. When designing a circuit, take into account this change in conversion efficiency over time. The ratio of fluctuation in conversion efficiency to fluctuation in infrared LED optical output is 1:1.

$$\frac{\mathrm{IC}/\mathrm{IF}\left(\mathrm{t}\right)}{\mathrm{IC}/\mathrm{IF}\left(\mathrm{0}\right)}=\frac{\mathrm{P}_{\mathrm{O}}\left(\mathrm{t}\right)}{\mathrm{P}_{\mathrm{O}}\left(\mathrm{0}\right)}$$

## Package Dimensions: TOSHIBA 11-8A1

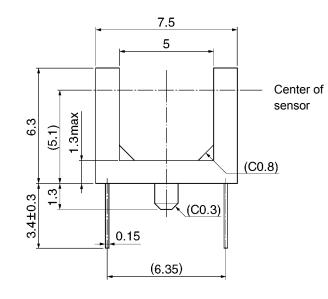
Slit width 0.5 Unit: mm



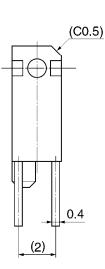
#### Tolerances are listed below unless

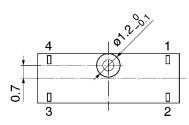
otherwise specified.

Dimensions	Tolerance		
4 mm or less	±0.1		
Greater then 4 mm	±0.2		



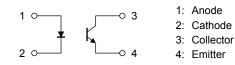
2.6

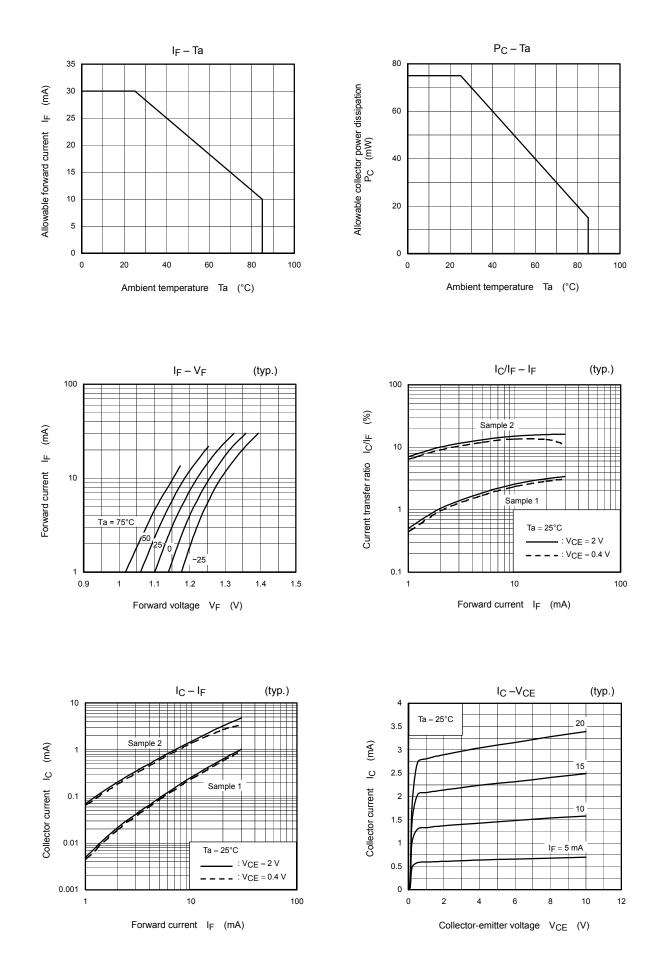




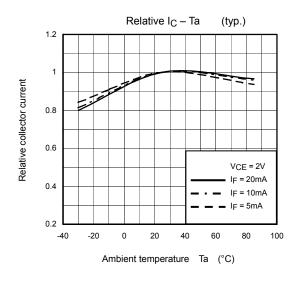
Weight: 0.1g (typ.)

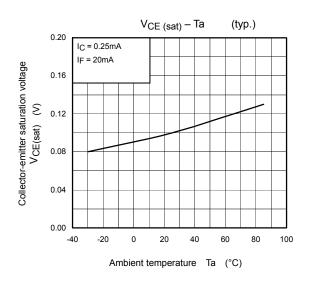
### **Pin Connection**

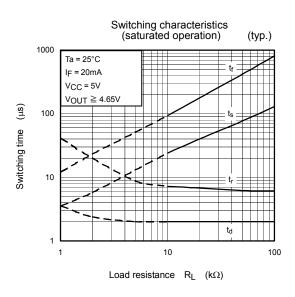


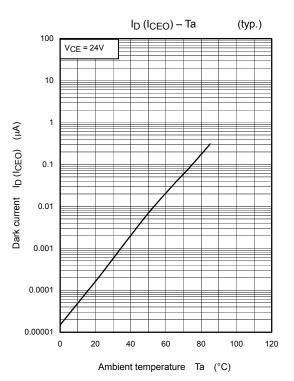


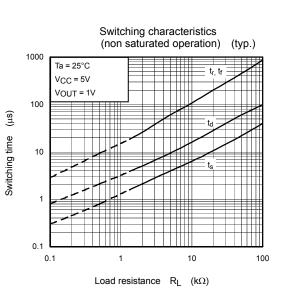
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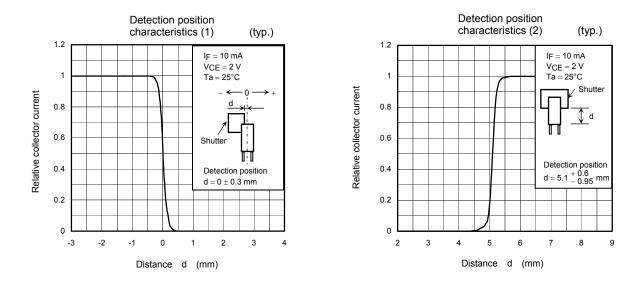






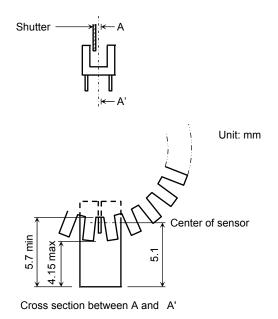






#### **Relative Positioning of Shutter and Device**

For normal operation, position the shutter and the device as shown in the figure below. By considering the device's detection direction characteristic and switching time, determine the shutter slit width and pitch.



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